

# **GMFS02** Analog Force Sensor

#### **General Introduction**

GMFS02 is an analog force sensor especially designed for consumer applications like touch panels, seamless buttons, and smart shoes. It is housed in a compact  $2.5 \times 2.1 \times 1.0$  mm<sup>3</sup> package. The force sensor is based on the industry-recognized piezo-resistive technology featuring long-term stability and EMC robustness. The force sensor is capable of continuously measuring forces from 0N up to 10N.

Focusing on micro force measurement, the high sensitivity, and the high resolution makes GMFS02 especially suitable for applications that detect forces from hand related movement such as finger taps or pen drawing.

#### **Features**

- O Operation range:
  - Force: 0~10N
  - Temperature: -40~+85°C
- O Force resolution:
  - Up to1mN
- O Supply voltage:
  - VDD: +1V ~ +5V

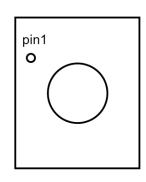
- O RoHS-compliance package:
  - LGA-4L package
  - Footprint:  $2.5 \times 2.1 \text{ mm}^2$
  - Height: 0.8 mm; 1.0 mm at force point

#### **Applications**

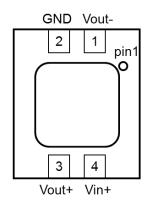
Force buttons, painting stylus, gaming, robotic end-effectors, and insoles of smart shoes



**Side View** 



**Top View** 



**Bottom View** 



# **Specifications**

Table 1: Pin Descriptions

Pin#	Name	Description		
1	Vout-	Analog output voltage -		
2	GND	Ground pin		
3	Vout+	Analog output voltage +		
4	Vin+	Power supply in		

Table 2: Specification

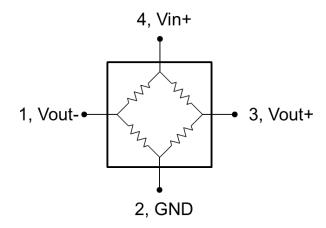
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Operation voltage	VDD		1	3.0	5	V
Operation current				550		μΑ
Impedance				5.4		$\mathrm{k}\Omega$
Temperature range	Ta		-40	+25	+85	°C
Force range	F		0	_	10	N
Span@10N				270		mV/V
Zero offset			0	-25	-50	mV/V
Sensitivity			_	81	_	mV/N at 3V
Linearity				±10		%Span
Noise (RMS)				0.01		mV

Table 3: Absolute Maximum Rating

			0	
Parameter	Symbol	Min.	Max.	Unit
Power supply voltage	VDD		5.5	V
Overload force	FMAX	0	20	N
Storage temperature	TST	-40	+85	$^{\circ}\mathrm{C}$
ESD	HBM	_	±2	kV

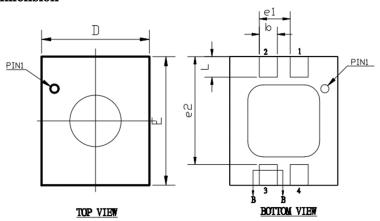


## Block diagram

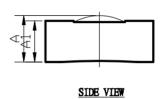


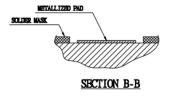
## Package

#### **Outline Dimension**



	DIMENSION				
SYMBOL	(MM)				
	MIN.	N□M.	MAX.		
Α	0.80	1.0	1.20		
A1	-	0.80	-		
D	2.0	2.1	2.2		
Ε	2.40	2.5	2.60		
b	0.30	0.35	0.40		
L	0.35	0.40	0.45		
e1	-	0.60	-		
e2	-	2.10	-		



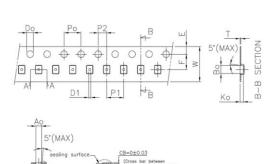


#### NOTE

1. CONTROL DIMENSION : MILLIMETER.

### Tape and Reel Dimensions

A-A SECTION



2.6X2.1mm PKG SIZE					
unit: mm	Standard	Data	Tolerance		
Ao	EIA-481	2.35	±0.1		
Во	EIA-481	2.85	±0.1		
Ко	EIA-481	1.25	±0.1		
Ро	EIA-481	4.0	±0.1		
P1	EIA-481	8.0	±0.1		
P2	EIA-481	2.0	±0.05		
Т	EIA-481	0.3	±0.05		
E	EIA-481	1.75	±0.1		
F	EIA-481	5.5	±0.05		
Do	EIA-481	1.5	+ 0.1 - 0		
D1	EIA-481	1.5	min		
w	EIA-481	12.0	±0.3		



PIN 1 DIRECTION



## Recommended PCB Foot Print Layout

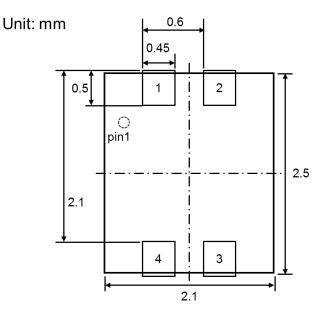


Figure 2: Layout Recommendation for PCB Land Pad

#### **RoHS Compliance**

GMEMS LGA packaged sensors are compliant with Restrictions on Hazardous Substances (RoHS) and having lead-free terminations. Reflow profiles applicable to those processes can be used successfully for soldering the devices.

#### Moisture Sensitivity Level

GMFS02 package MSL rating is Level 3.



# Document History and Modification

Revision No.	Description	Date
V0.10	Preliminary datasheet	2018.04.10
	Modification of the force range to 10N	
V0.20	Modification of the overload force to 20N	2018.09.13
V 0.20	Addition of the block diagram	
	Addition of the tape and reel dimensions	
V0.30	Modification of the package outline dimensions and the	2018.10.15
V 0.50	recommended PCB foot print layout	
V0.50	Update specification of offset, linearity, and SPAN	2020.08.10
V0.51	Correct specification of sensitivity	2020.08.21